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ASSOCIATION CONNECTING LECTRONICS INDUSTRIES IPC Projection Converting	<u>ect Initia</u>	tio	on Notificati	on (PIN) Form		
PIN Number assigned: 354			Date: April 24, 2007			
IPC Document number: IPC-2588 Amendr	ment 1					
DOCUMENT/PROJECT TITLE:						
Sectional Requirements for Implementation of Part List Product Data Description (Amendment 1)						
SCOPE, SUMMARY OR ABSTRACT OF DOCUMENT/PROJECT:						
This standard specifies data formats used to describe parts lists and bill of material generation methodologies. These formats may be used for transmitting information between printed board designers, board fabricators, and assembly manufacturers. The information can be used for both manual and digital interpretations. Since the requirements are important to every file, the XML schema may be reused in every business-to-business transaction. This standard calls out the details defined in the generic standard (IPC-2581) that are required to accomplish these focused tasks.						
AMENDED PIN SUBMITTAL:						
Change of Scope Other (give reason)						
			Developing Subcommittee/Task group(# and Title): 2-17 CAD/CAM Convergence Subcommittee			
List other Committees impacted by this project:						
PURPOSE OF DOCUMENT PROJECT:						
☐ Create a new IPC Standard			Form new committee/ subcommittee / task group			
□ Revise an existing IPC Standard			☐ Dissolve Group			
Reaffirm an existing Standard			Develop other program (define)			
Supplement to a current standard (e.g. addendum)			☐ Discontinue a project			
☐ Withdraw existing Standard/Guideline			Other (please specify)			
ANSI APPROVAL						
This document will be submitted for ANSI Approval: Yes No						
If Yes, complete the following information:						
Project Need :						
Includes text from ISO or IEC standard?	Yes No U	nit o	f Measure: Metric			
DEVELOPING COMMITTEE/ SUBCOMMITTEE/TASK GROUP CHAIR(S):						
Project Chair / Leader	Karen E. McConnell			Phone: 856-792-9417		
	Lockheed Martin		ath or	Fax: 856-792-9455		
	3 Executive Campus, 4 Cherry Hill, NJ 08002			Email: karen.e.mcconnell@lmco.com		
IPC Staff Liaison: Dieter Bergman						
<u> </u>	IPC MISS	ION	STATEMENT			
The IPC is a United States based trade association dedicated to furthering the competitive excellence and financial success of its members worldwide who are participants in the electronic interconnect industry.						
In pursuit of these objectives, the IPC will devote resources to management improvement and technology enhancement programs, the creation of relevant standards, protection of the environment and pertinent government relations.						
The IPC encourages the active participants of all its Regular, Allied and Associate Members in these activities and commits to full cooperation with all related national and international organizations.						

X Yes

☐ No – Explain importance:

Does this project fit within the IPC mission statement?

Committed	Name	Company		
Volunteers	Danette Pappas	SOLECTRON		
	Paul Barrow	Valor		
	Art Griesser	NIST		
	Norwood Sisson	Sisson & Associates		
	Chris Czernel	Mentor Graphics	Mentor Graphics	
	Göran Lundqvist	Ericsson	Ericsson	
	Tero Kärkkäinen	Nokia		
Milestones	Milestones		Date	
	1. First Draft		August 2007	
	2. Industry Review (30 day Cycle)	September 2007		
	3. Comment Resolution Meeting	December 2007		
	4. Final Ballot Circulation	January 2008		
5. Comment Resolution			February 2008	
	6. Publish Final Document		March 2008	
	TO BE COMPI	LETED BY IPC STAFF		
Date Submitted	to TAEC			
Date Approved	by TAEC			
PIN submitted t	o ANSI (if applicable)			

Form Revised April 13, 2007